

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	250	V
Peak Repetitive Reverse Voltage	V _{RRM}	250	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	177	V
Forward Continuous Current (Note 5)	I _{FM}	200	mA
Average Rectified Output Current (Note 5)	I _O	250	mA
Non-Repetitive Peak Forward Surge Current	I _{FSM}	10	A
@ t = 10μs		6	
@ t = 10ms		2	

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	300	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R _{θJA}	417	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	V _{(BR)R}	250	—	V	I _R = 100μA
Forward Voltage	V _F	—	1.0 1.25	V	I _F = 100mA I _F = 200mA
Reverse Current (Note 6)	I _R	—	100 100	nA μA	V _R = 200V V _R = 200V, T _J = +150°C
Total Capacitance	C _T	—	5	pF	V _R = 0, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	50	ns	I _F = I _R = 30mA, I _{rr} = 0.1 x I _R , R _L = 100Ω

Note: 5. Part mounted on FR-4 substrate, 2oz Cu pad board with recommended pad layout, which can be found on our website at <http://www.diodes.com/package-outlines.html>.

6. Short duration pulse test used to minimize self-heating effect.

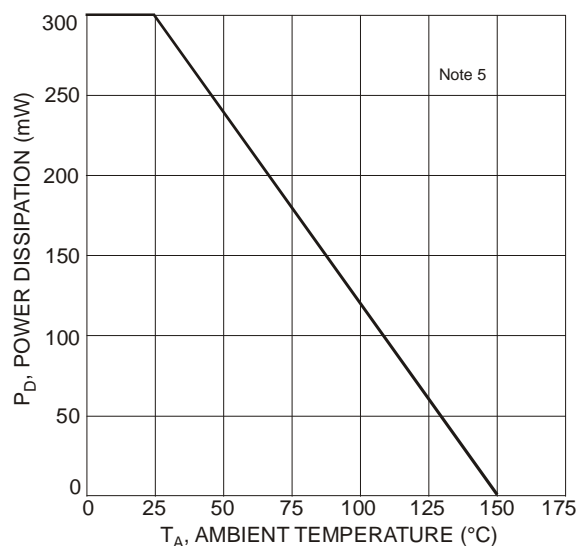


Fig. 1 Power Derating Curve, Total Package

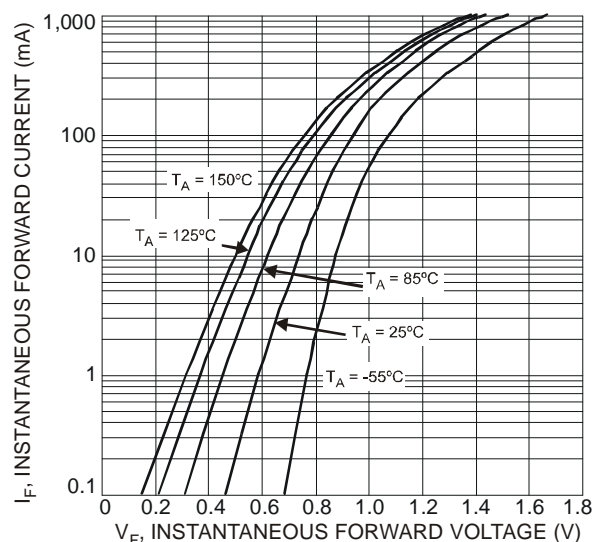


Fig. 2 Typical Forward Characteristics, Per Element

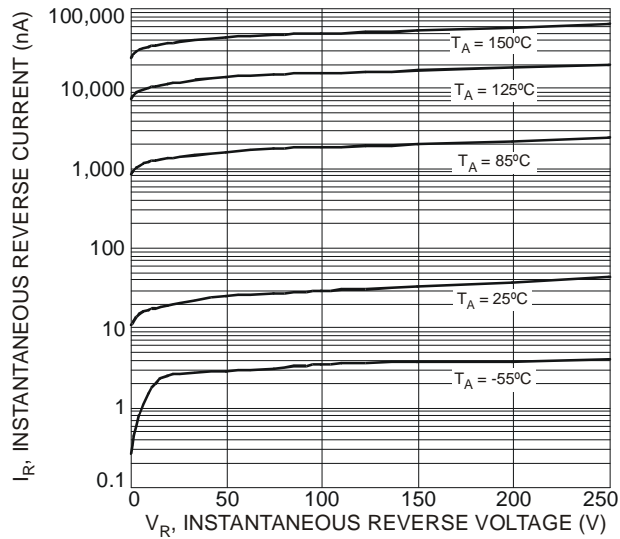


Fig. 3 Typical Reverse Characteristics, Per Element

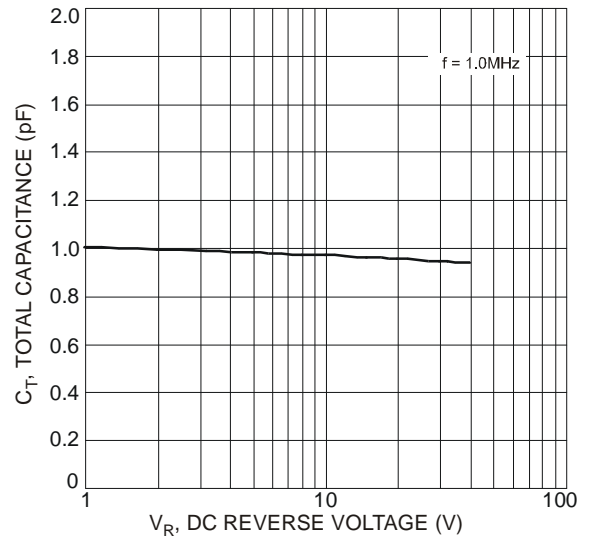
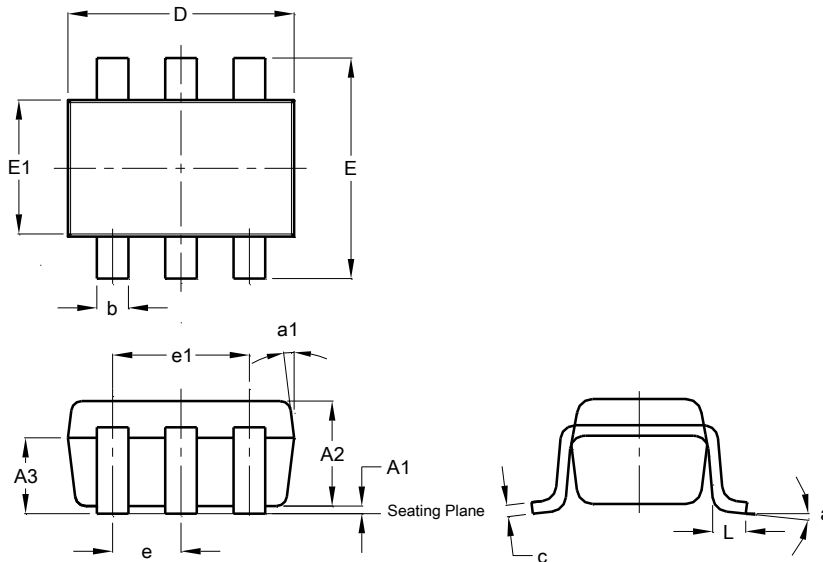


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

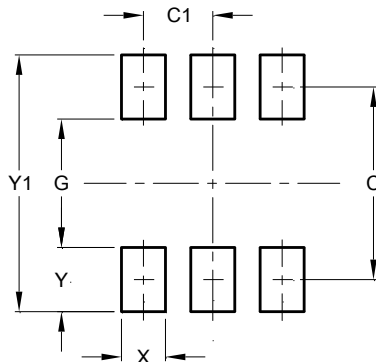
Please see <http://www.diodes.com/package-outlines.html> for the latest version.



SOT26			
Dim	Min	Max	Typ
A1	0.013	0.10	0.05
A2	1.00	1.30	1.10
A3	0.70	0.80	0.75
b	0.35	0.50	0.38
c	0.10	0.20	0.15
D	2.90	3.10	3.00
e	-	-	0.95
e1	-	-	1.90
E	2.70	3.00	2.80
E1	1.50	1.70	1.60
L	0.35	0.55	0.40
a	-	-	8°
a1	-	-	7°
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.



Dimensions	Value (in mm)
C	2.40
C1	0.95
G	1.60
X	0.55
Y	0.80
Y1	3.20

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